Pin Description

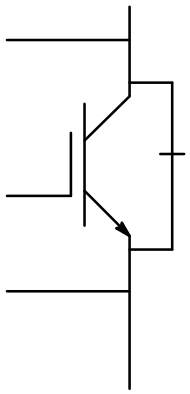


Figure 1. Pin Description

MODULE CHARACTERISTICS (T_{vj} = 25°C, Unless Otherwise Specified)

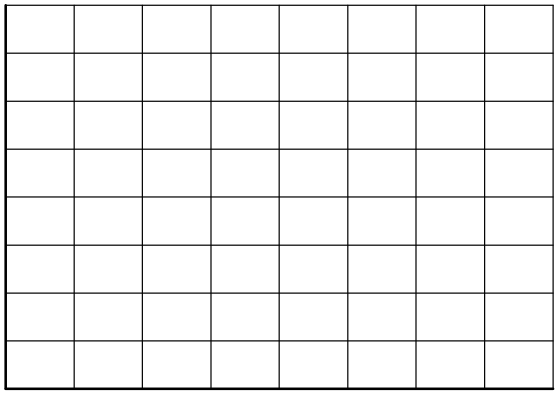
Symbol	Parameter	Rating	Unit
T_{vj}	Operating Junction Temperature	−40 to 175	°C
T_{STG}	Storage Temperature	−40 to 125	°C
V_{ISO}	Isolation Voltage (DC, 0 Hz, 1 s)	4200	V
L_{sCE}	Stray Inductance	8	nH
RCC'+EE'	Module Lead Resistance, Terminals − Chip	0.75	mΩ
G			

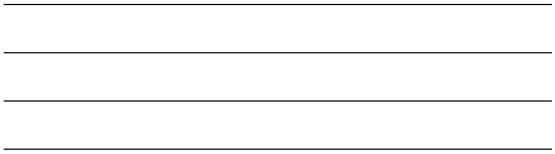
VE−Trac™ Direct Module NVH820S75L4SPC

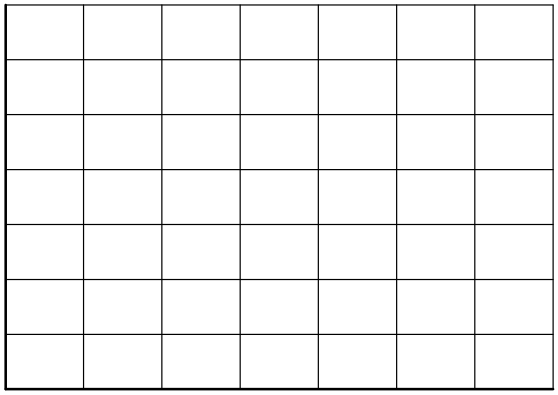
CHARACTERISTICS OF INVERSE DIODE (T_{vj} = 25°C, Unless Otherwise Specified)

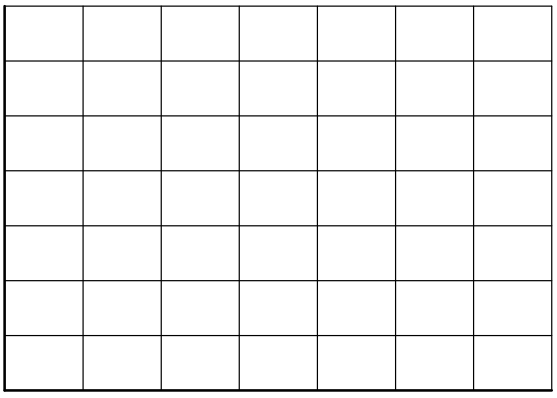
Symbol	Parameters	Conditions		Min	Typ	Max	Unit
V_F	Diode Forward Voltage (Terminal)	I_F = 600 A	T_{vj} = 25°C	−	1.70	1.95	V
	Diode Forward Voltage (Chip)	I_F = 600 A	T_{vj} = 25°C T_{vj} = 150°C T_{vj} = 175°C	− − −	1.60 1.55 1.50	1.85 − −	
		I_F = 820 A	T_{vj} = 25°C T_{vj} = 150°C T_{vj} = 175°C	− − −	1.70 1.70 1.65	− − −	
E_{rr}	Reverse Recovery Energy	I_F = 600 A, V_R = 400 V, V_{GE} = −8 V, Rg.on = 4 Ω					

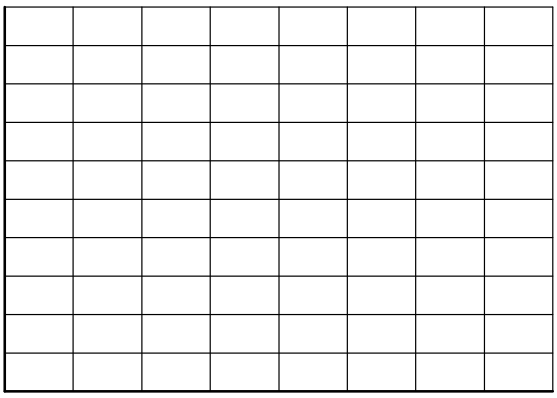
TYPICAL CHARACTERISTICS



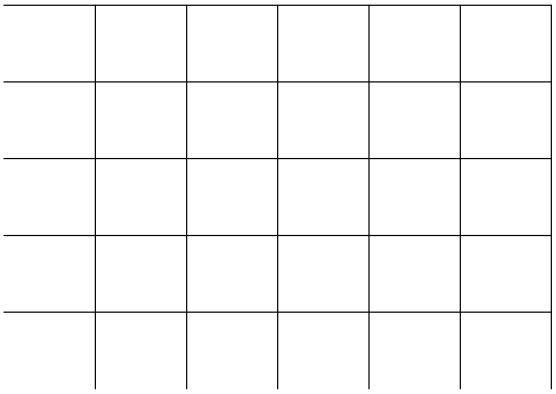


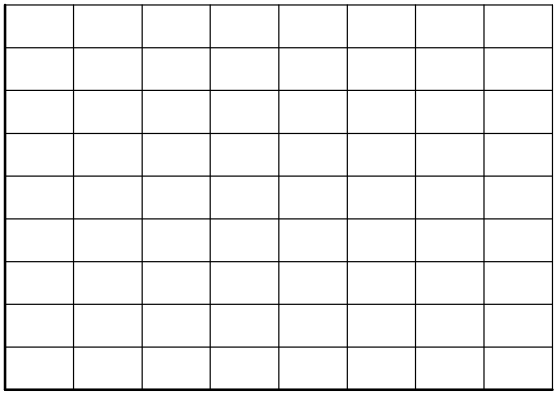


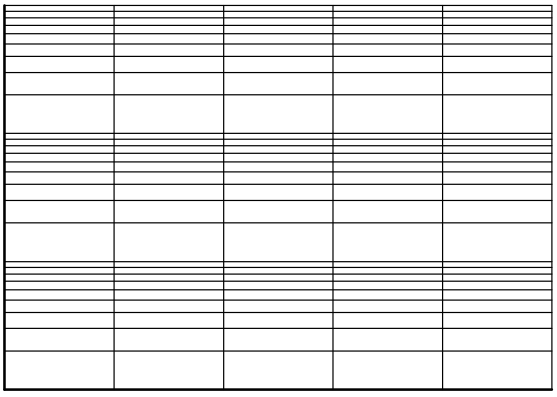




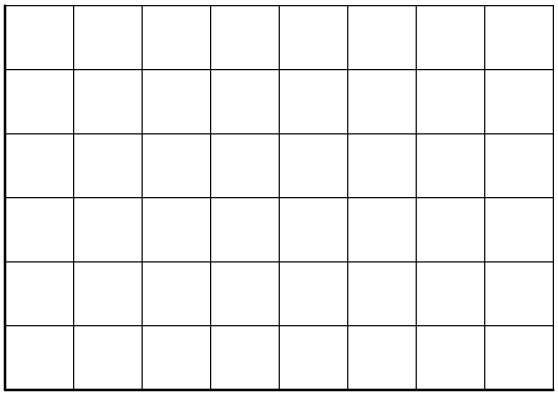
TYPICAL CHARACTERISTICS

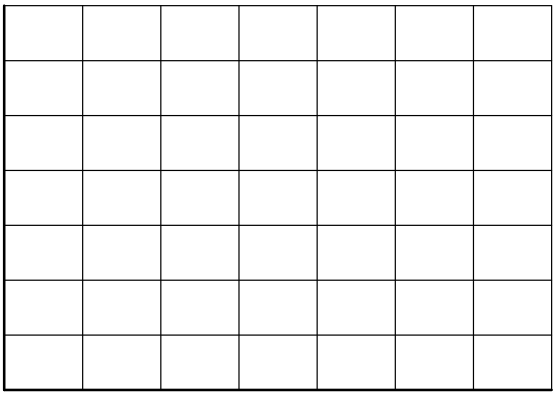


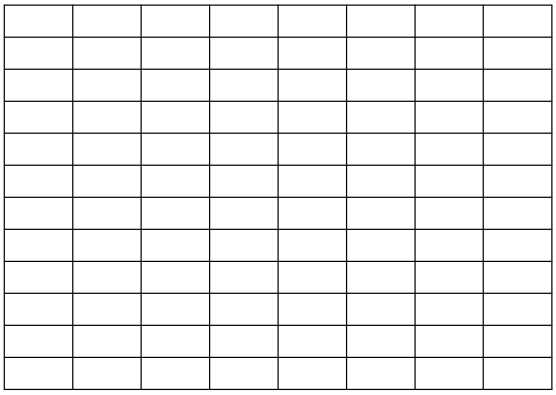


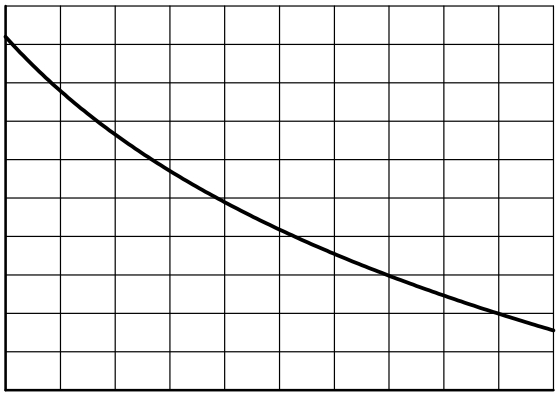


TYPICAL CHARACTERISTICS









VE−Trac™ Direct Module NVH820S75L4SPC

SSDC33, 154.50x92.0 (SPC)
CASE 183AC
ISSUE A

DATE 11 DEC 2019

GENERIC
MARKING DIAGRAM*

XXXXXXXXXXXXXXXXXXXXXG
ATYYWW

XXXXX = Specific Device Code
G = Pb−Free Package
AT = Assembly & Test Site Code
YYWW= Year and Work Week Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “ ▪”, may or may not be present. Some products may not follow the Generic Marking.

SSDC33, 154.50x92.0 (SPC)
CASE 183AC
ISSUE A

DATE 11 DEC 2019

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